# Features

- Fast Read Access Time 45 ns
- Low-Power CMOS Operation
  - 100 µA Max Standby
- 20 mA Max Active at 5 MHz
- JEDEC Standard Packages
  - 28-lead PDIP
  - 32-lead PLCC
  - 28-lead TSOP and SOIC
- 5V ± 10% Supply
- High Reliability CMOS Technology
  - 2,000V ESD Protection
  - 200 mA Latchup Immunity
- Rapid Programming Algorithm 100 µs/Byte (Typical)
- CMOS and TTL Compatible Inputs and Outputs
- Integrated Product Identification Code
- Industrial and Automotive Temperature Ranges
- Green (Pb/Halide-free) Packaging Option

# 1. Description

The AT27C256R is a low-power, high-performance 262,144-bit one-time programmable read-only memory (OTP EPROM) organized 32K by 8 bits. It requires only one 5V power supply in normal read mode operation. Any byte can be accessed in less than 45 ns, eliminating the need for speed reducing WAIT states on high-performance microprocessor systems.

Atmel's scaled CMOS technology provides low-active power consumption, and fast programming. Power consumption is typically only 8 mA in Active Mode and less than 10  $\mu$ A in Standby.

The AT27C256R is available in a choice of industry-standard JEDEC-approved one time programmable (OTP) plastic DIP, PLCC, SOIC, and TSOP packages. All devices feature two-line control ( $\overline{CE}$ ,  $\overline{OE}$ ) to give designers the flexibility to prevent bus contention.

With 32K byte storage capability, the AT27C256R allows firmware to be stored reliably and to be accessed by the system without the delays of mass storage media.

Atmel's AT27C256R has additional features to ensure high quality and efficient production use. The Rapid Programming Algorithm reduces the time required to program the part and guarantees reliable programming. Programming time is typically only 100  $\mu$ s/byte. The Integrated Product Identification Code electronically identifies the device and manufacturer. This feature is used by industry-standard programming equipment to select the proper programming algorithms and voltages.



256K (32K x 8) OTP EPROM

# AT27C256R





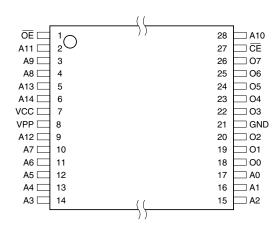
# 2. Pin Configurations

Pin Name	Function
A0 - A14	Addresses
00 - 07	Outputs
CE	Chip Enable
ŌĒ	Output Enable
NC	No Connect

### 2.1 28-lead PDIP/SOIC Top View

		$\bigcirc$	
VPP 🗆	1	28	3 D VCC
A12 🗆	2	27	7 🗆 A14
A7 🗆	3	26	5 🗆 A13
A6 🗆	4	25	5 🗆 A8
A5 🗆	5	24	4 🗆 A9
A4 🗆	6	23	3 🗆 A11
A3 🗆	7	22	
A2 🗆	8	21	1 🗆 A10
A1 🗆	9	20	
A0 🗆	10	19	9 🗆 07
O0 🗆	11	18	3 🗆 06
01 🗆	12	17	7 🗆 05
O2 🗆	13	16	5 🗆 04
GND 🗆	14	15	5 🗆 03

### 2.3 28-lead TSOP Top View – Type 1



# 2.2 32-lead PLCC Top View

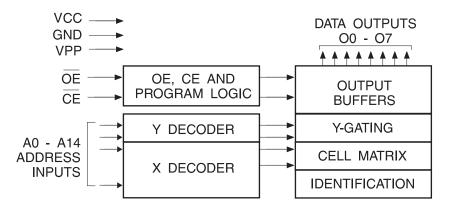
		DA7	] A12	<b>J VPP</b>	NC	D VCC	□ A14	□ A13	
		4	e		-	32	3	8	1
A6 🗆	5				0	ო	ო	ິ29	🗆 A8
A5 🗆	6							28	🗆 A9
A4 🗆	7							27	🗆 A11
АЗ 🗆	8							26	□ NC
A2 🗆	9							25	□ OE
A1 🗆	10	0						24	🗆 A10
A0 🗆	1	1						23	
NC 🗆	1:	2						22	07
O0 🗆	1:	3_		~	~	~	~	_21	06 🗆
		4	15	16	17	18	19	20	
									-
		Б	8	ð	ç	ő	2	32	
		0	0	G		0	0	0	

Note: PLCC Package Pins 1 and 17 are Don't Connect.

### 3. System Considerations

Switching between active and standby conditions via the Chip Enable pin may produce transient voltage excursions. Unless accommodated by the system design, these transients may exceed datasheet limits, resulting in device non-conformance. At a minimum, a 0.1  $\mu$ F high frequency, low inherent inductance, ceramic capacitor should be utilized for each device. This capacitor should be connected between the V<sub>CC</sub> and Ground terminals of the device, as close to the device as possible. Additionally, to stabilize the supply voltage level on printed circuit boards with large EPROM arrays, a 4.7  $\mu$ F bulk electrolytic capacitor should be utilized, again connected between the V<sub>CC</sub> and Ground terminals. This capacitor should be positioned as close as possible to the point where the power supply is connected to the array.

## 4. Block Diagram



## 5. Absolute Maximum Ratings\*

Temperature Under Bias55°C to +125°C
Storage Temperature65°C to +150°C
Voltage on Any Pin with Respect to Ground2.0V to +7.0V <sup>(1)</sup>
Voltage on A9 with Respect to Ground2.0V to +14.0V <sup>(1)</sup>
V <sub>PP</sub> Supply Voltage with Respect to Ground2.0V to +14.0V <sup>(1)</sup>

\*NOTICE: Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

Note: 1. Minimum voltage is -0.6V DC which may undershoot to -2.0V for pulses of less than 20 ns. Maximum output pin voltage is V<sub>CC</sub> + 0.75V dc which may overshoot to +7.0 volts for pulses of less than 20 ns.





# 6. Operating Modes

Mode/Pin	CE	ŌE	Ai	V <sub>PP</sub>	Outputs
Read	V <sub>IL</sub>	V <sub>IL</sub>	Ai	V <sub>CC</sub>	D <sub>OUT</sub>
Output Disable	V <sub>IL</sub>	V <sub>IH</sub>	X <sup>(1)</sup>	V <sub>CC</sub>	High Z
Standby	V <sub>IH</sub>	X <sup>(1)</sup>	X <sup>(1)</sup>	V <sub>CC</sub>	High Z
Rapid Program <sup>(2)</sup>	V <sub>IL</sub>	V <sub>IH</sub>	Ai	V <sub>PP</sub>	D <sub>IN</sub>
PGM Verify <sup>(2)</sup>	X <sup>(1)</sup>	V <sub>IL</sub>	Ai	V <sub>PP</sub>	D <sub>OUT</sub>
Optional PGM Verify <sup>(2)</sup>	V <sub>IL</sub>	V <sub>IL</sub>	Ai	V <sub>CC</sub>	D <sub>OUT</sub>
PGM Inhibit <sup>(2)</sup>	V <sub>IH</sub>	V <sub>IH</sub>	X <sup>(1)</sup>	V <sub>PP</sub>	High Z
Product Identification <sup>(4)</sup>	V <sub>IL</sub>	V <sub>IL</sub>	$A9 = V_{H}^{(3)}$ $A0 = V_{IH} \text{ or } V_{IL}$ $A1 - A14 = V_{IL}$	V <sub>cc</sub>	Identification Code

Notes: 1. X can be  $V_{IL}$  or  $V_{IH}$ .

2. Refer to Programming Characteristics.

- 3.  $V_{H} = 12.0 \pm 0.5 V.$
- 4. Two identifier bytes may be selected. All Ai inputs are held low ( $V_{IL}$ ), except A9 which is set to  $V_H$  and A0 which is toggled low ( $V_{IL}$ ) to select the Manufacturer's Identification byte and high ( $V_{IH}$ ) to select the Device Code byte.

# 7. DC and AC Operating Conditions for Read Operation

		AT27C256R				
		-45	-70			
Operating Temp. (Case)	Ind.	-40° C - 85° C	-40° C - 85° C			
	Auto.		-40° C - 125° C			
V <sub>CC</sub> Supply		5V ± 10%	5V ± 10%			

# 8. DC and Operating Characteristics for Read Operation

Symbol	Parameter	Condition		Min	Мах	Units
1	Input Lood Current		Ind.		±1	μA
ILI	Input Load Current	$V_{IN} = 0V$ to $V_{CC}$	Auto.		±5	μA
1	Outrast Leokene Courset		Ind.		±5	μA
I <sub>LO</sub>		$V_{OUT} = 0V$ to $V_{CC}$	Auto.		±10	μA
I <sub>PP1</sub> <sup>(2)</sup>	V <sub>PP</sub> <sup>(1)</sup> Read/Standby Current	V <sub>PP</sub> = V <sub>CC</sub>			10	μA
1		$I_{SB1}$ (CMOS), $\overline{CE} = V_{CC} \pm 0.3V$			100	μA
I <sub>SB</sub>	V <sub>CC</sub> <sup>(1)</sup> Standby Current	$I_{SB2}$ (TTL), $\overline{CE}$ = 2.0 to	V to $V_{CC}$ $0V$ to $V_{CC}$ 1nd. Auto. Auto. $V_{CC}$ MOS), $\overline{CE} = V_{CC} \pm 0.3V$ $\Gamma L$ , $\overline{CE} = 2.0$ to $V_{CC} + 0.5V$ Hz, $I_{OUT} = 0$ mA, $\overline{E} = V_{IL}$ 1 mA		1	mA
I <sub>CC</sub>	V <sub>CC</sub> Active Current	f = 5 MHz, I <sub>OUT</sub> = 0 mA,	$\overline{E} = V_{IL}$		20	mA
V <sub>IL</sub>	Input Low Voltage			-0.6	0.8	V
V <sub>IH</sub>	Input High Voltage			2.0	V <sub>CC</sub> + 0.5	V
V <sub>OL</sub>	Output Low Voltage	I <sub>OL</sub> = 2.1 mA			0.4	V
V <sub>OH</sub>	Output High Voltage	I <sub>OH</sub> = -400 μA		2.4		V

Notes: 1.  $V_{CC}$  must be applied simultaneously with or before  $V_{PP}$  and removed simultaneously with or after  $V_{PP}$ .

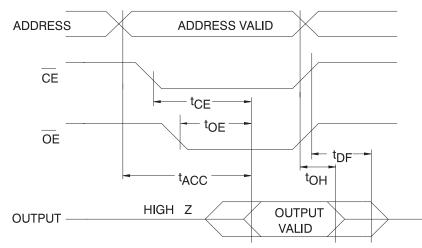
2. V<sub>PP</sub> may be connected directly to V<sub>CC</sub>, except during programming. The supply current would then be the sum of I<sub>CC</sub> and I<sub>PP</sub>

# 9. AC Characteristics for Read Operation

				AT27C256R				
			-45		-70			
Symbol	Parameter	Condition	Min	Max	Min	Мах	Units	
t <sub>ACC</sub> <sup>(1)</sup>	Address to Output Delay	$\overline{CE} = \overline{OE} = V_{IL}$		45		70	ns	
t <sub>CE</sub> <sup>(1)</sup>	CE to Output Delay	$\overline{OE} = V_{IL}$		45		70	ns	
t <sub>OE</sub> <sup>(1)</sup>	OE to Output Delay	$\overline{CE} = V_{IL}$		20		30	ns	
t <sub>DF</sub> <sup>(1)</sup>	OE or CE High to Output Float, Whichever Occurred First			20		25	ns	
t <sub>OH</sub>	Output Hold from Address, $\overline{CE}$ or $\overline{OE}$ , Whichever Occurred First		7		7		ns	

Note: 1. See AC Waveforms for Read Operation.

# **10.** AC Waveforms for Read Operation<sup>(1)</sup>

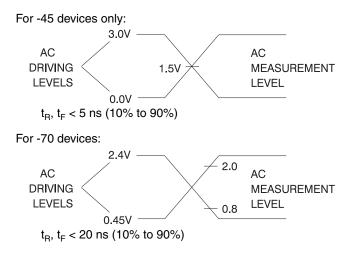


- Notes: 1. Timing measurement reference level is 1.5V for -45 devices. Input AC drive levels are  $V_{IL} = 0.0V$  and  $V_{IH} = 3.0V$ . Timing measurement reference levels for all other speed grades are  $V_{OL} = 0.8V$  and  $V_{OH} = 2.0V$ . Input AC drive levels are  $V_{IL} = 0.45V$  and  $V_{IH} = 2.4V$ .
  - 2.  $\overline{OE}$  may be delayed up to  $t_{CE}$   $t_{OE}$  after the falling edge of  $\overline{CE}$  without impact on  $t_{CE}$ .
  - 3.  $\overline{\text{OE}}$  may be delayed up to  $t_{ACC}$   $t_{OE}$  after the address is valid without impact on  $t_{ACC}$ .
  - 4. This parameter is only sampled and is not 100% tested.
  - 5. Output float is defined as the point when data is no longer driven.

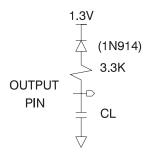




# **11. Input Test Waveforms and Measurement Levels**



## 12. Output Test Load



Note: 1.  $C_L = 100 \text{ pF}$  including jig capacitance, except for the -45 devices, where  $C_L = 30 \text{ pF}$ .

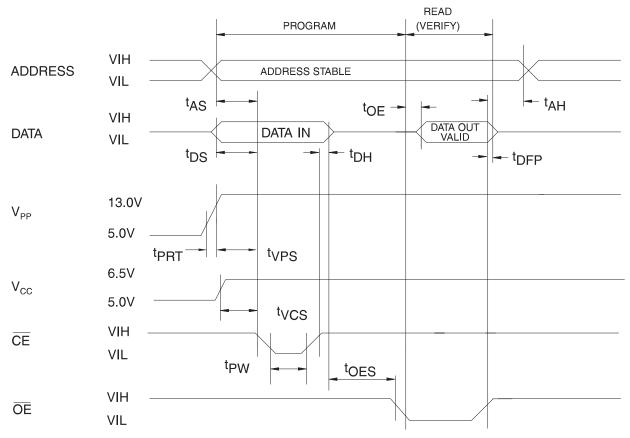
## 13. Pin Capacitance

 $f = 1 \text{ MHz}, T = 25^{\circ}C^{(1)}$ 

Symbol	Тур	Мах	Units	Conditions
C <sub>IN</sub>	4	6	pF	$V_{IN} = 0V$
C <sub>OUT</sub>	8	12	pF	$V_{OUT} = 0V$

Note: 1. Typical values for nominal supply voltage. This parameter is only sampled and is not 100% tested.

# 14. Programming Waveforms<sup>(1)</sup>



- Notes: 1. The Input Timing Reference is 0.8V for  $\rm V_{IL}$  and 2.0V for  $\rm V_{IH}.$ 
  - 2.  $t_{OE}$  and  $t_{DFP}$  are characteristics of the device but must be accommodated by the programmer.
  - 3. When programming the AT27C256R a 0.1  $\mu$ F capacitor is required across V<sub>PP</sub> and ground to suppress spurious voltage transients.

# **15. DC Programming Characteristics**

 $T_{A} = 25 \pm 5^{\circ}C, \ V_{CC} = 6.5 \pm 0.25V, \ V_{PP} = 13.0 \pm 0.25V$ 

			Lir		
Symbol	Parameter	Test Conditions	Min	Max	Units
ILI	Input Load Current	$V_{IN} = V_{IL}, V_{IH}$		±10	μA
V <sub>IL</sub>	Input Low Level		-0.6	0.8	V
V <sub>IH</sub>	Input High Level		2.0	V <sub>cc</sub> + 1	V
V <sub>OL</sub>	Output Low Volt	I <sub>OL</sub> = 2.1 mA		0.4	V
V <sub>OH</sub>	Output High Volt	I <sub>OH</sub> = -400 μA	2.4		V
I <sub>CC2</sub>	V <sub>CC</sub> Supply Current (Program and Verify)			25	mA
I <sub>PP2</sub>	V <sub>PP</sub> Current	$\overline{CE} = V_{IL}$		25	mA
V <sub>ID</sub>	A9 Product Identification Voltage		11.5	12.5	V





# **16. AC Programming Characteristics**

 $T_{A} = 25 \pm 5^{\circ}C, \ V_{CC} = 6.5 \pm 0.25V, \ V_{PP} = 13.0 \pm 0.25V$ 

			Lir		
Symbol	Parameter	Test Conditions <sup>(1)</sup>	Min	Max	Units
t <sub>AS</sub>	Address Setup Time		2		μs
t <sub>OES</sub>	OE Setup Time	Input Rise and Fall Times	2		μs
t <sub>DS</sub>	Data Setup Time	(10% to 90%) 20 ns	2		μs
t <sub>AH</sub>	Address Hold Time	Input Pulse Levels	0		μs
t <sub>DH</sub>	Data Hold Time	Input Pulse Levels 0.45V to 2.4V	2		μs
t <sub>DFP</sub>	OE High to Output Float Delay <sup>(2)</sup>		0	130	ns
t <sub>VPS</sub>	V <sub>PP</sub> Setup Time	Input Timing Reference Level	2		μs
t <sub>VCS</sub>	V <sub>CC</sub> Setup Time	0.8V to 2.0V	2		μs
t <sub>PW</sub>	CE Program Pulse Width <sup>(3)</sup>	Output Timing Reference Level	95	105	μs
t <sub>OE</sub>	Data Valid from OE <sup>(2)</sup>	0.8V to 2.0V		150	ns
t <sub>PRT</sub>	V <sub>PP</sub> Pulse Rise Time During Programming		50		ns

Notes: 1.  $V_{CC}$  must be applied simultaneously or before  $V_{PP}$  and removed simultaneously or after  $V_{PP}$ 

2. This parameter is only sampled and is not 100% tested. Output Float is defined as the point where data is no longer driven – see timing diagram.

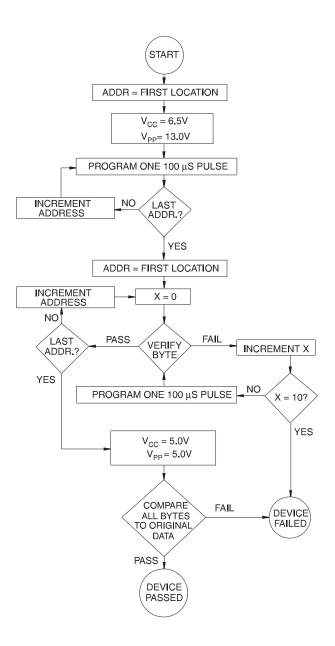
3. Program Pulse width tolerance is 100  $\,\mu\text{sec}\pm5\%.$ 

# 17. Atmel's AT27C256R Integrated Product Identification Code

		Pins							Hex	
Codes	A0	07	O6	O5	04	O3	02	01	00	Data
Manufacturer	0	0	0	0	1	1	1	1	0	1E
Device Type	1	1	0	0	0	1	1	0	0	8C

## 18. Rapid Programming Algorithm

A 100  $\mu$ s  $\overline{CE}$  pulse width is used to program. The address is set to the first location. V<sub>CC</sub> is raised to 6.5V and V<sub>PP</sub> is raised to 13.0V. Each address is first programmed with one 100  $\mu$ s  $\overline{CE}$  pulse without verification. Then a verification/reprogramming loop is executed for each address. In the event a byte fails to pass verification, up to 10 successive 100  $\mu$ s pulses are applied with a verification after each pulse. If the byte fails to verify after 10 pulses have been applied, the part is considered failed. After the byte verifies properly, the next address is selected until all have been checked. V<sub>PP</sub> is then lowered to 5.0V and V<sub>CC</sub> to 5.0V. All bytes are read again and compared with the original data to determine if the device passes or fails.







# **19. Ordering Information**

## 19.1 Standard Package

t <sub>ACC</sub>	I <sub>CC</sub> (mA)				
(ns)	Active	Standby	Ordering Code	Package	Operation Range
45	20	0.1	AT27C256R-45JI	32J	Industrial
			AT27C256R-45PI	28P6	(-40° C to 85° C)
			AT27C256R-45RI	28R <sup>(1)</sup>	
			AT27C256R-45TI	28T	
70	20	0.1	AT27C256R-70JI	32J	Industrial
			AT27C256R-70PI	28P6	(-40° C to 85° C)
			AT27C256R-70RI	28R <sup>(1)</sup>	
			AT27C256R-70TI	28T	
	20	0.1	AT27C256R-70JA	32J	Automotive
			AT27C256R-70PA	28P6	(-40° C to 125° C)
			AT27C256R-70RA	28R <sup>(1)</sup>	

Note:

Not recommended for new designs. Use Green package option.

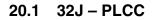
# 19.2 Green Package (Pb/Halide-free)

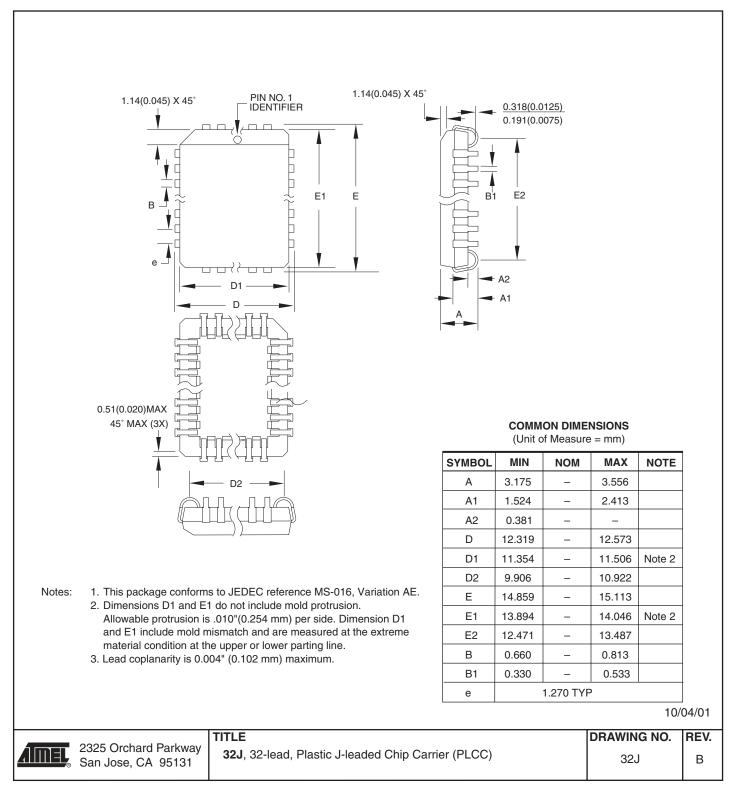
t <sub>ACC</sub> (ns)	I <sub>CC</sub> (mA)				
	Active	Standby	Ordering Code	Package	<b>Operation Range</b>
45	20	0.1	AT27C256R-45JU	32J	Industrial
			AT27C256R-45PU	28P6	(-40° C to 85° C)
			AT27C256R-45RU	28R <sup>(1)</sup>	
			AT27C256R-45TU	28T	
70	20	0.1	AT27C256R-70JU	32J	Industrial
			AT27C256R-70PU	28P6	(-40° C to 85° C)
			AT27C256R-70RU	28R <sup>(1)</sup>	
			AT27C256R-70TU	28T	

Note: 1. The 28-pin SOIC package is not recommended for new designs.

Package Type					
32J	32-lead, Plastic J-Leaded Chip Carrier (PLCC)				
28P6	28-lead, 0.600" Wide, Plastic Dual Inline Package (PDIP)				
28R	28-lead, 0.330" Wide, Plastic Gull Wing Small Outline (SOIC)				
28T	28-lead, Thin Small Outline Package (TSOP)				

# 20. Packaging Information

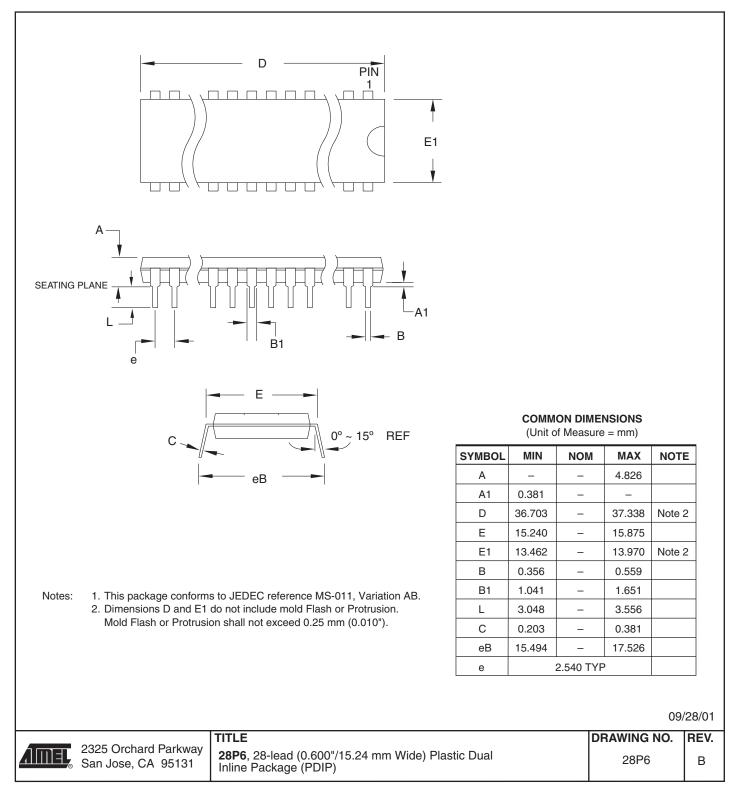




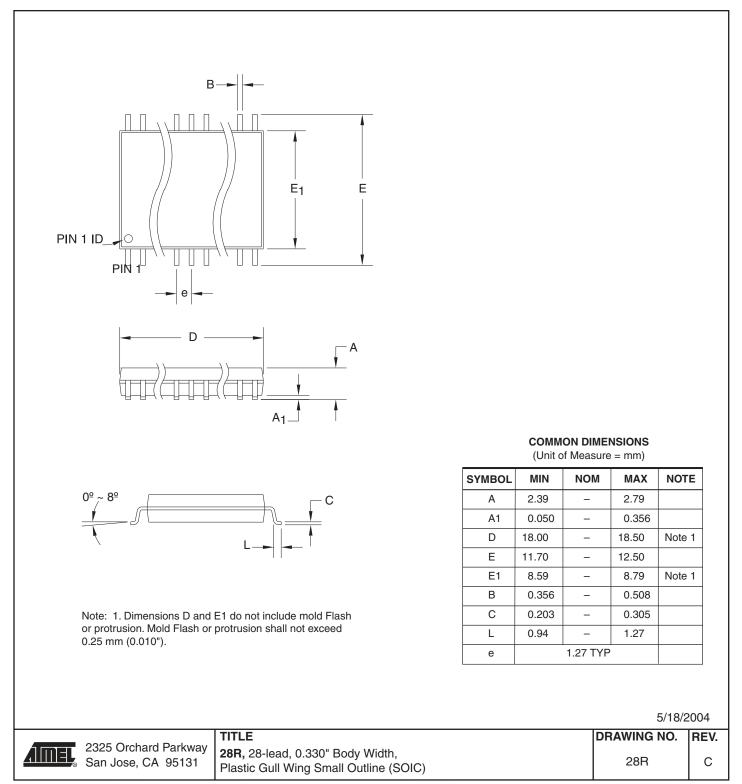




### 20.2 28P6 - PDIP



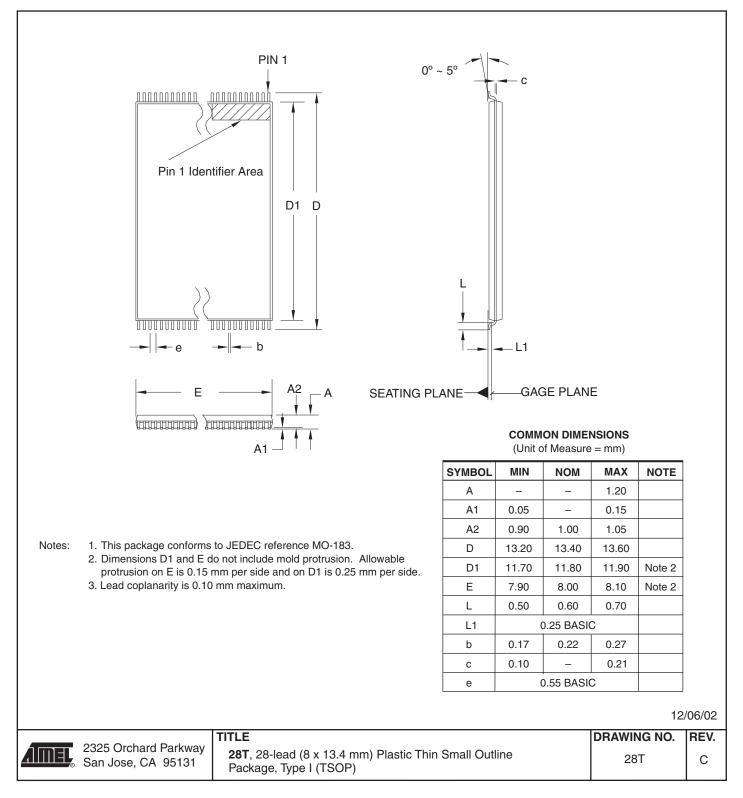
### 20.3 28R - SOIC







### 20.4 28T - TSOP





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